intersil

March 1997

CMOS 16-Bit Microprocessor

Features

- Compatible with NMOS 8086
- Completely Static CMOS Design

-	DC	 	 	5MHz (80C86)
-	DC	 	 	8MHz (80C86-2)

- Low Power Operation
- 1MByte of Direct Memory Addressing Capability
- 24 Operand Addressing Modes
- Bit, Byte, Word and Block Move Operations
- 8-Bit and 16-Bit Signed/Unsigned Arithmetic
 - Binary, or Decimal
 - Multiply and Divide
- Wide Operating Temperature Range

-	C80C86	٠.	 										. 0 ^c	C	to	+7	'0°	,C
-	180C86.		 		 							_	40°	C	to	+8	35°	,C

- M80C86 -55°C to +125°C

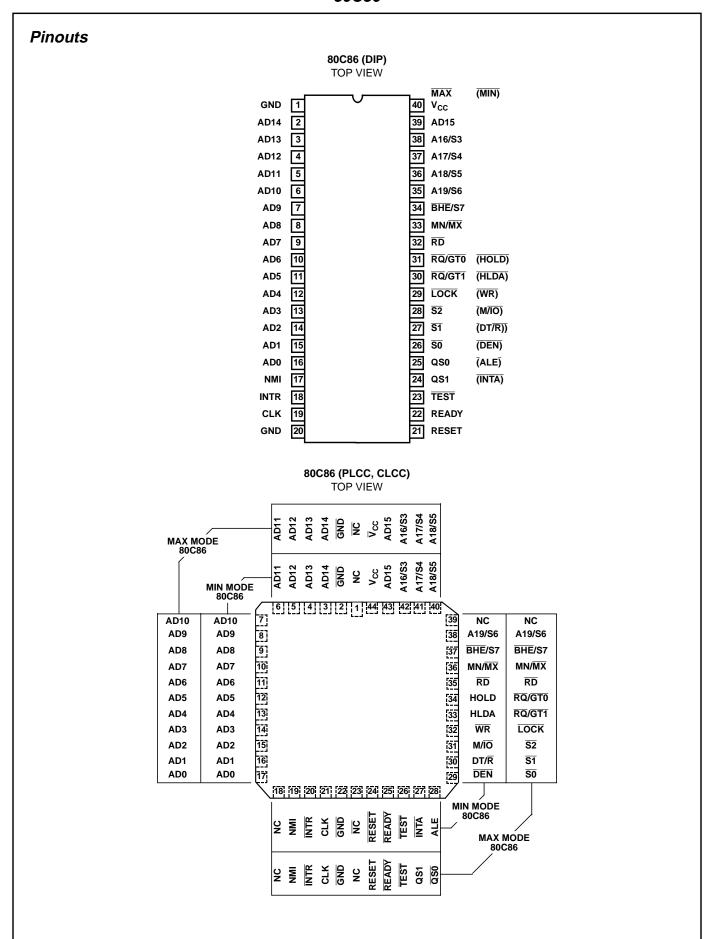
Description

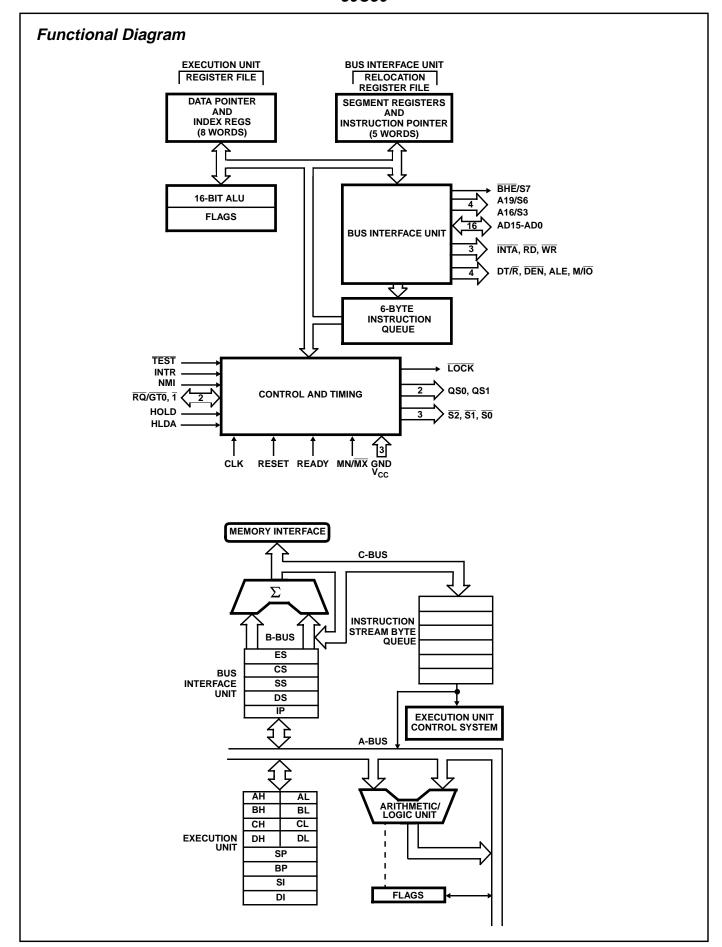
The Intersil 80C86 high performance 16-bit CMOS CPU is manufactured using a self-aligned silicon gate CMOS process (Scaled SAJI IV). Two modes of operation, minimum for small systems and maximum for larger applications such as multiprocessing, allow user configuration to achieve the highest performance level. Full TTL compatibility (with the exception of CLOCK) and industry standard operation allow use of existing NMOS 8086 hardware and software designs.

Ordering Information

			- C-C-C-L	PKG.
PACKAGE	TEMP. RANGE	5MHz	8MHz	NO.
PDIP	0°C to +70°C	CP80C86	CP80C86-2	E40.6
~\\(\(\(\(\(\)\\\\\\\\\\\\\\\\\\\\\\\\\	-40°C to +85°C	IP80C86	IP80C86-2	E40.6
PLCC	0°C to +70°C	CS80C86	CS80C86-2	N44.65
	-40°C to +85°C	IS80C86	IS80C86-2	N44.65
CERDIP	0°C to +70°C	CD80C86	CD80C86-2	F40.6
	-40°C to +85°C	ID80C86	ID80C86-2	F40.6
	-55°C to +125°C	MD80C86/B	MD80C86- 2/B	F40.6
SMD#	-55°C to +125°C	8405201QA	8405202QA	F40.6
CLCC	-55°C to +125°C	MR80C86/B	MR80C86- 2/B	J44.A
SMD#	-55°C to +125°C	8405201XA	8405202XA	J44.A







Pin Description

The following pin function descriptions are for 80C86 systems in either minimum or maximum mode. The "Local Bus" in these description is the direct multiplexed bus interface connection to the 80C86 (without regard to additional bus buffers).

SYMBOL	PIN NUMBER	TYPE				DE	SCRIPTION					
AD15-AD0	2-16, 39	I/O	data (T2, T3, TW D0. It is LOW dur or I/O operations dition chip select ance to the last v	ADDRESS DATA BUS: These lines constitute the time multiplexed memory/IO address (T1) and data (T2, T3, TW, T4) bus. A0 is analogous to BHE for the lower byte of the data bus, pins D7-D0. It is LOW during Ti when a byte is to be transferred on the lower portion of the bus in memory or I/O operations. Eight-bit oriented devices tied to the lower half would normally use A0 to condition chip select functions (See BHE). These lines are active HIGH and are held at high impedance to the last valid logic level during interrupt acknowledge and local bus "hold acknowledge" or "grant sequence".								
A19/S6 A18/S5 A17/S4 A16/S3	35-38	0	erations. During information is avenue the interrupt enal are encoded as some This information	I/O operation ailable on to the FLAG loshown. Indicates when the thick the	ons these lire bit (S5) which se	se lines nes durir is updat egment r	ne four most significant addre are LOW. During memory and ag T2, T3, TW, T4. S6 is alwa ed at the beginning of each egister is presently being use the last valid logic level dur	d I/O operations, statuays LOW. The status clock cycle. S4 and Seed for data accessing.				
					S4	S3	CHARACTERISTICS]				
				<u> </u>	0	0	Alternate Data					
				-	0	1	Stack					
				<u> </u>	1	0	Code or None					
					1	1	Data					
			is LOW during T	half of the 1 for read,	bus wou write, a	uld norm nd interi	ally use BHE to condition chipup tacknowledge cycles whe	p select functions. BH en a byte is to be trans				
			is LOW during T ferred on the hig T4. The signal is	half of the 1 for read, h portion of active LO ledge and	bus wou write, a of the bu W, and local bu	uld norm nd interi us. The S is held a us "hold a	ally use BHE to condition chipupt acknowledge cycles whe status information is availat high impedance to the last acknowledge" or "grant seque	p select functions. BH en a byte is to be tran- able during T2, T3 ar valid logic level durir				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and	bus wou write, a of the bu W, and local bu	uld norm nd interi us. The S is held a us "hold a	ally use BHE to condition chipupt acknowledge cycles whe status information is availat high impedance to the last acknowledge" or "grant seque	en a byte is to be trans able during T2, T3 and valid logic level durin				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and terrupt ack	bus wou write, a of the bu W, and local bu nowledo	uld norm nd interi us. The S is held a us "hold a ge cycle.	ally use BHE to condition chi upt acknowledge cycles whe 67 status information is availa at high impedance to the last acknowledge" or "grant seque	p select functions. BH en a byte is to be tran able during T2, T3 ar valid logic level durir				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and terrupt ack	bus wou write, a of the bu W, and local bu nowledg	uld norm nd interi us. The S is held a us "hold a ge cycle. Who	ally use BHE to condition chip upt acknowledge cycles whe so status information is available things in the last acknowledge" or "grant sequence to the last acknowledge" or "grant sequence CHARACTERISTICS	p select functions. BHen a byte is to be tran able during T2, T3 ar t valid logic level durin ence", it is LOW durin				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and terrupt acki	bus wou write, a write, a of the bu W, and local bu nowledg	uld norm nd interr us. The S is held a is "hold g ge cycle. Who	ally use BHE to condition chip upt acknowledge cycles whence of status information is available thigh impedance to the last acknowledge" or "grant sequence of the control	p select functions. BHen a byte is to be tran able during T2, T3 are valid logic level during ence", it is LOW during				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and terrupt ack	bus work write, a of the bu W, and local bu nowledg A0 1	uld norm nd interr us. The S is held a is "hold g ge cycle. Who	ally use BHE to condition chip upt acknowledge cycles whe stratus information is availated this impedance to the last acknowledge" or "grant sequence CHARACTERISTICS alle Word er Byte From/to Odd Address er Byte From/to Even address	p select functions. BHen a byte is to be transable during T2, T3 are valid logic level during ence", it is LOW during				
			is LOW during T ferred on the hig T4. The signal is interrupt acknow	half of the 1 for read, h portion of active LO ledge and terrupt acki BHE 0 0 1	bus worker, a soft the but with and local but nowled to be a soft of the but with a soft the but with a so	uld norm nd interr us. The S is held a is "hold a ge cycle. Who Upp Low	ally use BHE to condition chip upt acknowledge cycles whe stratus information is availated this impedance to the last acknowledge" or "grant sequence CHARACTERISTICS alle Word er Byte From/to Odd Address er Byte From/to Even address	p select functions. BHen a byte is to be tran able during T2, T3 are valid logic level during ence", it is LOW during				
RD	32	0	is LOW during T ferred on the hig T4. The signal is interrupt acknow T1 for the first interrupt acknow the second of the second	half of the 1 for read, h portion of active LO ledge and terrupt acking the service of the servi	bus wot write, a of the but w, and local but nowledged a control of the but with the but with the but with the but would be but with the but with th	uld norm nd interr us. The S is held a is "hold a ge cycle. Who Upp Low Non the proc r \$\overline{52}\$ pin. OW dur 8 80C86	ally use BHE to condition chip upt acknowledge cycles whe stratus information is availated this impedance to the last acknowledge" or "grant sequence CHARACTERISTICS alle Word er Byte From/to Odd Address er Byte From/to Even address	p select functions. BHen a byte is to be transle during T2, T3 are valid logic level during ence", it is LOW during the selection of the selec				

Pin Description (Continued)

The following pin function descriptions are for 80C86 systems in either minimum or maximum mode. The "Local Bus" in these description is the direct multiplexed bus interface connection to the 80C86 (without regard to additional bus buffers).

SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
INTR	18	I	INTERRUPT REQUEST: is a level triggered input which is sampled during the last clock cycle of each instruction to determine if the processor should enter into an interrupt acknowledge operation. A subroutine is vectored to via an interrupt vector lookup table located in system memory. It can be internally masked by software resetting the interrupt enable bit. INTR is internally synchronized. This signal is active HIGH.
TEST	23	I	TEST: input is examined by the "Wait" instruction. If the TEST input is LOW execution continues, otherwise the processor waits in an "Idle" state. This input is synchronized internally during each clock cycle on the leading edge of CLK.
NMI	17	I	NON-MASKABLE INTERRUPT: is an edge triggered input which causes a type 2 interrupt. A subroutine is vectored to via an interrupt vector lookup table located in system memory. NMI is not maskable internally by software. A transition from LOW to HIGH initiates the interrupt at the end of the current instruction. This input is internally synchronized.
RESET	21	I	RESET: causes the processor to immediately terminate its present activity. The signal must transition LOW to HIGH and remain active HIGH for at least four clock cycles. It restarts execution, as described in the Instruction Set description, when RESET returns LOW. RESET is internally synchronized.
CLK	19	I	CLOCK: provides the basic timing for the processor and bus controller. It is asymmetric with a 33% duty cycle to provide optimized internal timing.
VCC	40		VCC: +5V power supply pin. A $0.1\mu F$ capacitor between pins 20 and 40 is recommended for decoupling.
GND	1, 20		GND: Ground. Note: both must be connected. A $0.1\mu F$ capacitor between pins 1 and 20 is recommended for decoupling.
MN/MX	33	I	MINIMUM/MAXIMUM: Indicates what mode the processor is to operate in. The two modes are discussed in the following sections.

Minimum Mode System

The following pin function descriptions are for the 80C86 in minimum mode (i.e., $MN/\overline{MX} = V_{CC}$). Only the pin functions which are unique to minimum mode are described; all other pin functions are as described below.

SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
M/ĪŌ	28	0	STATUS LINE: logically equivalent to $\overline{S2}$ in the maximum mode. It is used to distinguish a memory access from an I/O access. M/\overline{IO} becomes valid in the T4 preceding a bus cycle and remains valid until the final T4 of the cycle (M = HIGH, I/O = LOW). M/\overline{IO} is held to a high impedance logic one during local bus "hold acknowledge".
WR	29	0	WRITE: indicates that the processor is performing a write memory or write I/O cycle, depending on the state of the M/\overline{IO} signal. \overline{WR} is active for T2, T3 and TW of any write cycle. It is active LOW, and is held to high impedance logic one during local bus "hold acknowledge".
ĪNTĀ	24	0	INTERRUPT ACKNOWLEDGE: is used as a read strobe for interrupt acknowledge cycles. It is active LOW during T2, T3 and TW of each interrupt acknowledge cycle. Note that INTA is never floated.
ALE	25	0	ADDRESS LATCH ENABLE: is provided by the processor to latch the address into the 82C82/82C83 address latch. It is a HIGH pulse active during clock LOW of T1 of any bus cycle. Note that ALE is never floated.

Minimum Mode System (Continued)

The following pin function descriptions are for the 80C86 in minimum mode (i.e., $MN/\overline{MX} = V_{CC}$). Only the pin functions which are unique to minimum mode are described; all other pin functions are as described below.

SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
DT/R	27	0	DATA TRANSMIT/RECEIVE: is needed in a minimum system that desires to use a data bus transceiver. It is used to control the direction of data flow through the transceiver. Logically, DT/\overline{R} is equivalent to $\overline{S1}$ in maximum mode, and its timing is the same as for $M\overline{IO}$ (T = HIGH, R = LOW). DT/\overline{R} is held to a high impedance logic one during local bus "hold acknowledge".
DEN	26	0	DATA ENABLE: provided as an output enable for a bus transceiver in a minimum system which uses the transceiver. $\overline{\text{DEN}}$ is active LOW during each memory and I/O access and for $\overline{\text{INTA}}$ cycles. For a read or $\overline{\text{INTA}}$ cycle it is active from the middle of T2 until the middle of T4, while for a write cycle it is active from the beginning of T2 until the middle of T4. $\overline{\text{DEN}}$ is held to a high impedance logic one during local bus "hold acknowledge".
HOLD HLDA	31, 30	0	HOLD: indicates that another master is requesting a local bus "hold". To be an acknowledged, HOLD must be active HIGH. The processor receiving the "hold" will issue a "hold acknowledge" (HLDA) in the middle of a T4 or TI clock cycle. Simultaneously with the issuance of HLDA, the processor will float the local bus and control lines. After HOLD is detected as being LOW, the processor will lower HLDA, and when the processor needs to run another cycle, it will again drive the local bus and control lines. HOLD is not an asynchronous input. External synchronization should be provided if the system cannot otherwise guarantee the setup time.

Maximum Mode System

The following pin function descriptions are for the 80C86 system in maximum mode (i.e., MN/MX - GND). Only the pin functions which are unique to maximum mode are described below.

SYMBOL	PIN NUMBER	TYPE		DESCRIPTION							
\$0 \$1 \$2	26 27 28	0 0 0	STATUS: is active during T4, T1 and T2 and is returned to the passive state (1, 1, 1) during T3 or during TW when READY is HIGH. This status is used by the 82C88 Bus Controller to generate all memory and I/O access control signals. Any change by \$\overline{52}\$, \$\overline{51}\$ or \$\overline{50}\$ during T4 is used to indicate the beginning of a bus cycle, and the return to the passive state in T3 or TW is used to indicate the end of a bus cycle. These signals are held at a high impedance logic one state during "grant sequence".								
				<u>52</u>	<u>S1</u>	S0	CHARACTERISTICS				
				0	0	0	Interrupt Acknowledge				
				0	0	1	Read I/O Port				
				0	1	0	Write I/O Port				
				0	1	1	Halt				
				1	0	0	Code Access				
				1	0	1	Read Memory				
				1	1	0	Write Memory				
				1	1	1	Passive				
						•		•			

Maximum Mode System (Continued)

The following pin function descriptions are for the 80C86 system in maximum mode (i.e., MN/\overline{MX} - GND). Only the pin functions which are unique to maximum mode are described below.

SYMBOL	PIN NUMBER	TYPE				DESCRIPTION	
RQ/GT0 RQ/GT1	31, 30	I/O	the local bus at the RQ/GTO having it may be left untiming) 1. A pulse of 1 (to the 80C86) 2. During a T4 complete (pulse 2) indice "grant sequer cally from the sequent cally from the sequent cally from the sequent cally from the Each Masteridle CLK cycle of the request bus during T4 1. Request occupance (pure to current cycles) 2. Current cycles (sequent cycles) 3. Current cycles (sequent cycles) 4. A locked instruction of the local bus will (pure to current cycles) 5. Local bus will (pure to current cycles) 6. A memory cycles (pure to current cycles)	ne end of thigher price connected CLK wide (pulse 1). For TI clock cates that nee" state local bus K wide from the cate of the cate of the cate of the cate of the cycle of th	the processority than Fig. The requirements of the 80C86 at the next during "graph the requirements of the second and 4 (or TI if rechange of the second and the the Cole while the Cole when a sefore T2. Iow byte of first acknown the reed during of the within the reed during of the second the seco	quest is made the two possible events will	tional with shold device so D/GT Sequence request ("hold") questing master tit will enter the connected logitules 3) that the at the next CLK. Here must be one elease the local ence.
LOCK	29	0	while LOCK is ac remains active ur at a high impeda	ctive LOW. ntil the con nce logic o	The LOC npletion of one state o	tem bus masters are not to gain control of \overline{K} signal is activated by the "LOCK" prefix the next instruction. This signal is active Luring "grant sequence". In MAX mode, \overline{LC} \overline{INTA} cycle and removed during T2 of the	instruction and OW, and is held OCK is automat-
QS1, QSO	24, 25	0	tion is performed	ovide statı	us to allow	s valid during the CLK cycle after which the external tracking of the internal 80C86 insigh impedance.	
				QSI	QSO		
				0	0	No Operation	
				0	1	First byte of op code from queue	
				1	0	Empty the queue	
			1				

Functional Description

Static Operation

All 80C86 circuitry is of static design. Internal registers, counters and latches are static and require no refresh as with dynamic circuit design. This eliminates the minimum operating frequency restriction placed on other microprocessors. The CMOS 80C86 can operate from DC to the specified upper frequency limit. The processor clock may be stopped in either state (HIGH/LOW) and held there indefinitely. This type of operation is especially useful for system debug or power critical applications.

The 80C86 can be single stepped using only the CPU clock. This state can be maintained as long as is necessary. Single step clock operation allows simple interface circuitry to provide critical information for bringing up your system.

Static design also allows very low frequency operation (down to DC). In a power critical situation, this can provide extremely low power operation since 80C86 power dissipation is directly related to operating frequency. As the system frequency is reduced, so is the operating power until, ultimately, at a DC input frequency, the 80C86 power requirement is the standby current, $(500\mu A \text{ maximum})$.

Internal Architecture

The internal functions of the 80C86 processor are partitioned logically into two processing units. The first is the Bus Interface Unit (BIU) and the second is the Execution Unit (EU) as shown in the CPU functional diagram.

These units can interact directly, but for the most part perform as separate asynchronous operational processors. The bus interface unit provides the functions related to instruction fetching and queuing, operand fetch and store, and address relocation. This unit also provides the basic bus control. The overlap of instruction pre-fetching provided by this unit serves to increase processor performance through improved bus bandwidth utilization. Up to 6 bytes of the instruction stream can be queued while waiting for decoding and execution.

The instruction stream queuing mechanism allows the BIU to keep the memory utilized very efficiently. Whenever there is space for at least 2 bytes in the queue, the BIU will attempt a word fetch memory cycle. This greatly reduces "dead-time" on the memory bus. The queue acts as a First-In-First-Out (FIFO) buffer, from which the EU extracts instruction bytes as required. If the queue is empty (following a branch instruction, for example), the first byte into the queue immediately becomes available to the EU.

The execution unit receives pre-fetched instructions from the BIU queue and provides un-relocated operand addresses to the BIU. Memory operands are passed through the BIU for processing by the EU, which passes results to the BIU for storage.

Memory Organization

The processor provides a 20-bit address to memory, which locates the byte being referenced. The memory is organized as a linear array of up to 1 million bytes, addressed as 00000(H) to FFFFF(H). The memory is logically divided into

code, data, extra and stack segments of up to 64K bytes each, with each segment falling on 16-byte boundaries. (See Figure 1).

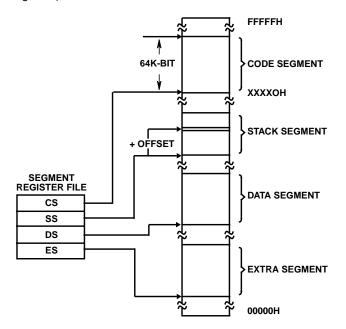


FIGURE 1. 80C86 MEMORY ORGANIZATION

TABLE 1.

TYPE OF MEMORY REFERENCE	DEFAULT SEGMENT BASE	ALTERNATE SEGMENT BASE	OFFSET
Instruction Fetch	CS	None	IP
Stack Operation	SS	None	SP
Variable (except following)	DS	CS, ES, SS	Effective Address
String Source	DS	CS, ES, SS	SI
String Destination	ES	None	DI
BP Used As Base Register	SS	CS, DS, ES	Effective Address

All memory references are made relative to base addresses contained in high speed segment registers. The segment types were chosen based on the addressing needs of programs. The segment register to be selected is automatically chosen according to the specific rules of Table 1. All information in one segment type share the same logical attributes (e.g. code or data). By structuring memory into re-locatable areas of similar characteristics and by automatically selecting segment registers, programs are shorter, faster and more structured. (See Table 1).

Word (16-bit) operands can be located on even or odd address boundaries and are thus, not constrained to even boundaries as is the case in many 16-bit computers. For address and data operands, the least significant byte of the word is stored in the lower valued address location and the most significant byte in the next higher address location. The BIU automatically performs the proper number of memory

accesses; one, if the word operand is on an even byte boundary and two, if it is on an odd byte boundary. Except for the performance penalty, this double access is transparent to the software. The performance penalty does not occur for instruction fetches; only word operands.

Physically, the memory is organized as a high bank (D15-D8) and a low bank (D7-D0) of 512K bytes addressed in parallel by the processor's address lines.

Byte data with even addresses is transferred on the D7-D0 bus lines, while odd addressed byte data (A0 HIGH) is transferred on the D15-D8 bus lines. The processor provides two enable signals, BHE and A_0 , to selectively allow reading from or writing into either an odd byte location, even byte location, or both. The instruction stream is fetched from memory as words and is addressed internally by the processor at the byte level as necessary.

In referencing word data, the BIU requires one or two memory cycles depending on whether the starting byte of the word is on an even or odd address, respectively. Consequently, in referencing word operands performance can be optimized by locating data on even address boundaries. This is an especially useful technique for using the stack, since odd address references to the stack may adversely affect the context switching time for interrupt processing or task multiplexing.

Certain locations in memory are reserved for specific CPU operations (See Figure 2). Locations from address FFFF0H through FFFFFH are reserved for operations including a jump to the initial program loading routine. Following RESET, the CPU will always begin execution at location FFFF0H where the jump must be located. Locations 00000H through 003FFH are reserved for interrupt operations. Each of the 256 possible interrupt service routines is accessed thru its own pair of 16-bit pointers (segment address pointer and offset address pointer). The first pointer, used as the offset address, is loaded into the IP and the second pointer, which designates the base address is loaded into the CS. At this point program control is transferred to the interrupt routine. The pointer elements are assumed to have been stored at the respective places in reserved memory prior to occurrence of interrupts.

Minimum and Maximum Operation Modes

The requirements for supporting minimum and maximum 80C86 systems are sufficiently different that they cannot be met efficiently using 40 uniquely defined pins. Consequently, the 80C86 is equipped with a strap pin (MN/ $\overline{\rm MX}$) which defines the system configuration. The definition of a certain subset of the pins changes, dependent on the condition of the strap pin. When the MN/ $\overline{\rm MX}$ pin is strapped to GND, the 80C86 defines pins 24 through 31 and 34 in maximum mode. When the MN/ $\overline{\rm MX}$ pin is strapped to V_{CC}, the 80C86 generates bus control signals itself on pins 24 through 31 and 34.

The minimum mode 80C86 can be used with either a multiplexed or demultiplexed bus. This architecture provides the 80C86 processing power in a highly integrated form.

The demultiplexed mode requires two 82C82 latches (for 64K addressability) or three 82C82 latches (for a full megabyte of addressing). An 82C86 or 82C87 transceiver can also be used if data bus buffering is required. (See Figure 6A.) The

80C86 provides \overline{DEN} and $\overline{DT/R}$ to control the transceiver, and ALE to latch the addresses. This configuration of the minimum mode provides the standard demultiplexed bus structure with heavy bus buffering and relaxed bus timing requirements.

The maximum mode employs the 82C88 bus controller (See Figure 6B). The 82C88 decodes status lines $\overline{S0}$, $\overline{S1}$ and $\overline{S2}$, and provides the system with all bus control signals.

Moving the bus control to the 82C88 provides better source and sink current capability to the control lines, and frees the 80C86 pins for extended large system features. Hardware lock, queue status, and two request/grant interfaces are provided by the 80C86 in maximum mode. These features allow coprocessors in local bus and remote bus configurations.

Bus Operation

The 80C86 has a combined address and data bus commonly referred to as a time multiplexed bus. This technique provides the most efficient use of pins on the processor while permitting the use of a standard 40 lead package. This "local bus" can be buffered directly and used throughout the system with address latching provided on memory and I/O modules. In addition, the bus can also be demultiplexed at the processor with a single set of 82C82 address latches if a standard non-multiplexed bus is desired for the system.

Each processor bus cycle consists of at least four CLK cycles. These are referred to as T1, T2, T3 and T4 (see Figure 3). The address is emitted from the processor during T1 and data transfer occurs on the bus during T3 and T4. T2 is used primarily for changing the direction of the bus during read operations. In the event that a "NOT READY" indication is given by the addressed device, "Wait" states (TW) are inserted between T3 and T4. Each inserted wait state is the same duration as a CLK cycle. Periods can occur between 80C86 driven bus cycles. These are referred to as idle" states (T_I) or inactive CLK cycles. The processor uses these cycles for internal housekeeping and processing.

During T1 of any bus cycle, the ALE (Address Latch Enable) signal is emitted (by either the processor or the 82C88 bus controller, depending on the MN/MX strap). At the trailing edge of this pulse, a valid address and certain status information for the cycle may be latched.

Status bits $\overline{S0}$, $\overline{S1}$ and $\overline{S2}$ are used by the bus controller, in maximum mode, to identify the type of bus transaction according to Table 2.

TABLE 2.

S2	S1	<u>S0</u>	CHARACTERISTICS
0	0	0	Interrupt
0	0	1	Read I/O
0	1	0	Write I/O
0	1	1	Halt
1	0	0	Instruction Fetch
1	0	1	Read Data from Memory
1	1	0	Write Data to Memory
1	1	1	Passive (No Bus Cycle)

Status bits S3 through S7 are time multiplexed with high order address bits and the \overline{BHE} signal, and are therefore valid during T2 through T4. S3 and S4 indicate which segment register (see Instruction Set Description) was used for this bus cycle in forming the address, according to Table 3.

S5 is a reflection of the PSW interrupt enable bit. S3 is always zero and S7 is a spare status bit.

TABLE 3.

S4	S3	CHARACTERISTICS
0	0	Alternate Data (Extra Segment)
0	1	Stack
1	0	Code or None
1	1	Data

I/O Addressing

In the 80C86, I/O operations can address up to a maximum of 64K I/O byte registers or 32K I/O word registers. The I/O address appears in the same format as the memory address on bus lines A15-A0. The address lines A19-A16 are zero in I/O operations. The variable I/O instructions which use register DX as a pointer have full address capability while the direct I/O instructions directly address one or two of the 256 I/O byte locations in page 0 of the I/O address space.

I/O ports are addressed in the same manner as memory locations. Even addressed bytes are transferred on the D7-D0 bus lines and odd addressed bytes on D15-D8. Care must be taken to ensure that each register within an 8-bit peripheral located on the lower portion of the bus be addressed as even.

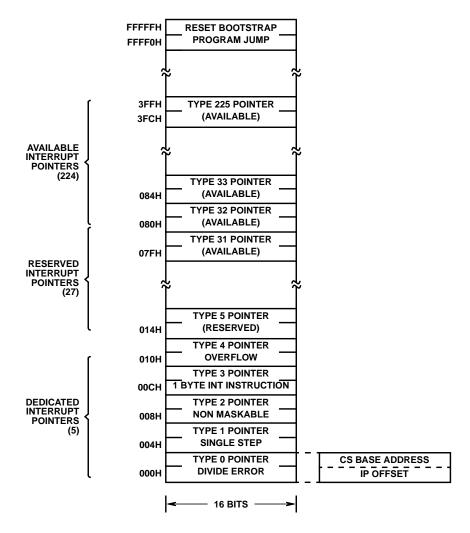
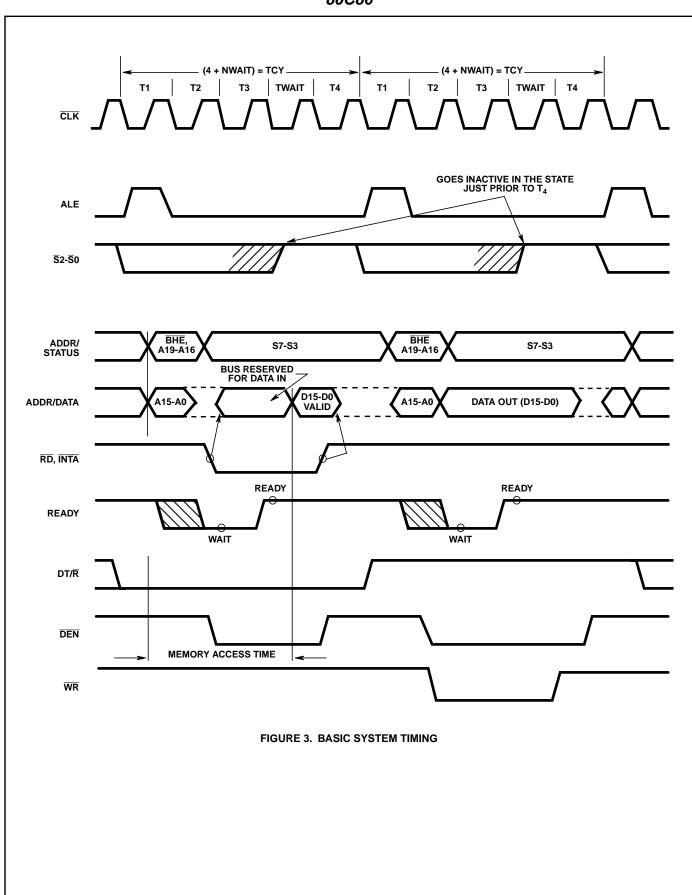


FIGURE 2. RESERVED MEMORY LOCATIONS



External Interface

Processor RESET and Initialization

Processor initialization or start up is accomplished with activation (HIGH) of the RESET pin. The 80C86 RESET is required to be HIGH for greater than 4 CLK cycles. The 80C86 will terminate operations on the high-going edge of RESET and will remain dormant as long as RESET is HIGH. The low-going transition of RESET triggers an internal reset sequence for approximately 7 clock cycles. After this interval, the 80C86 operates normally beginning with the instruction in absolute location FFFF0H. (See Figure 2). The RESET input is internally synchronized to the processor clock. At initialization, the HIGH-to-LOW transition of RESET must occur no sooner than $50\mu s$ (or 4 CLK cycles, whichever is greater) after power-up, to allow complete initialization of the 80C86.

NMI will not be recognized prior to the second CLK cycle following the end of RESET. If NMI is asserted sooner than nine clock cycles after the end of RESET, the processor may execute one instruction before responding to the interrupt.

Bus Hold Circuitry

To avoid high current conditions caused by floating inputs to CMOS devices and to eliminate need for pull-up/down resistors, "bus-hold" circuitry has been used on the 80C86 pins 2-16, 26-32 and 34-39. (See Figure 4A and Figure 4B). These circuits will maintain the last valid logic state if no driving source is present (i.e., an unconnected pin or a driving source which goes to a high impedance state). To overdrive the "bus hold" circuits, an external driver must be capable of supplying approximately $400\mu A$ minimum sink or source current at valid input voltage levels. Since this "bus hold" circuitry is active and not a "resistive" type element, the associated power supply current is negligible and power dissipation is significantly reduced when compared to the use of passive pull-up resistors.

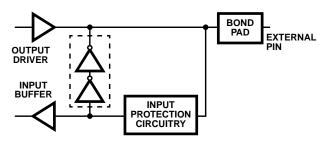


FIGURE 4A. BUS HOLD CIRCUITRY PIN 2-16, 34-39

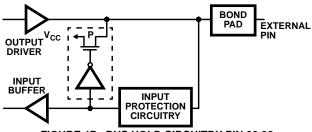


FIGURE 4B. BUS HOLD CIRCUITRY PIN 26-32

Interrupt Operations

Interrupt operations fall into two classes: software or hardware initiated. The software initiated interrupts and software aspects of hardware interrupts are specified in the Instruction Set Description. Hardware interrupts can be classified as non-maskable or maskable.

Interrupts result in a transfer of control to a new program location. A 256-element table containing address pointers to the interrupt service program locations resides in absolute locations 0 through 3FFH, which are reserved for this purpose. Each element in the table is 4 bytes in size and corresponds to an interrupt "type". An interrupting device supplies an 8-bit type number during the interrupt acknowledge sequence, which is used to "vector" through the appropriate element to the new interrupt service program location. All flags and both the Code Segment and Instruction Pointer register are saved as part of the $\overline{\text{INTA}}$ sequence. These are restored upon execution of an Interrupt Return (IRET) instruction.

Non-Maskable Interrupt (NMI)

The processor provides a single non-maskable interrupt pin (NMI) which has higher priority than the maskable interrupt request pin (INTR). A typical use would be to activate a power failure routine. The NMI is edge-triggered on a LOW-to-HIGH transition. The activation of this pin causes a type 2 interrupt.

NMI is required to have a duration in the HIGH state of greater than two CLK cycles, but is not required to be synchronized to the clock. Any positive transition of NMI is latched on-chip and will be serviced at the end of the current instruction or between whole moves of a block-type instruction. Worst case response to NMI would be for multiply, divide, and variable shift instructions. There is no specification on the occurrence of the low-going edge; it may occur before, during or after the servicing of NMI. Another positive edge triggers another response if it occurs after the start of the NMI procedure. The signal must be free of logical spikes in general and be free of bounces on the low-going edge to avoid triggering extraneous responses.

Maskable Interrupt (INTR)

The 80C86 provides a single interrupt request input (INTR) which can be masked internally by software with the resetting of the interrupt enable flag (IF) status bit. The interrupt request signal is level triggered. It is internally synchronized during each clock cycle on the high-going edge of CLK. To be responded to, INTR must be present (HIGH) during the clock period preceding the end of the current instruction or the end of a whole move for a block type instruction. INTR may be removed anytime after the falling edge of the first INTA signal. During the interrupt response sequence further interrupts are disabled. The enable bit is reset as part of the response to any interrupt (INTR, NMI, software interrupt or single-step), although the FLAGS register which is automatically pushed onto the stack reflects the state of the processor prior to the interrupt. Until the old FLAGS register is restored, the enable bit will be zero unless specifically set by an instruction.

During the response sequence (Figure 5) the processor executes two successive (back-to-back) interrupt acknowledge cycles. The 80C86 emits the \overline{LOCK} signal (Max mode only) from T2 of the first bus cycle until T2 of the second. A local bus "hold" request will not be honored until the end of the second bus cycle. In the second bus cycle, a byte is supplied to the 80C86 by the 82C59A Interrupt Controller, which identifies the source (type) of the interrupt. This byte is multiplied by four and used as a pointer into the interrupt vector lookup table. An INTR signal left HIGH will be continually responded to within the limitations of the enable bit and sample period. The INTERRUPT RETURN instruction includes a FLAGS pop which returns the status of the original interrupt enable bit when it restores the FLAGS.

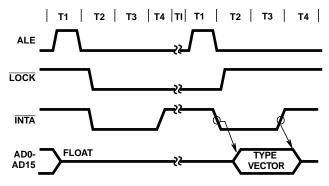


FIGURE 5. INTERRUPT ACKNOWLEDGE SEQUENCE

Halt

When a software "HALT" instruction is executed the processor indicates that it is entering the "HALT" state in one of two ways depending upon which mode is strapped. In minimum mode, the processor issues one ALE with no qualifying bus control signals. In maximum mode the processor issues appropriate HALT status on $\overline{S2}$, $\overline{S1}$, $\overline{S0}$ and the 82C88 bus controller issues one ALE. The 80C86 will not leave the "HALT" state when a local bus "hold" is entered while in "HALT". In this case, the processor reissues the HALT indicator at the end of the local bus hold. An NMI or interrupt request (when interrupts enabled) or RESET will force the 80C86 out of the "HALT" state.

Read/Modify/Write (Semaphore)

Operations Via Lock

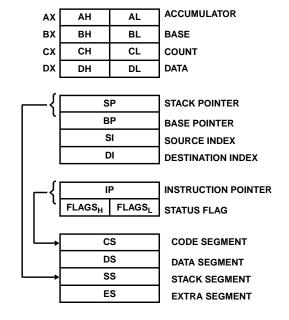
The LOCK status information is provided by the processor when consecutive bus cycles are required during the execution of an instruction. This gives the processor the capability of performing read/modify/write operations on memory (via the Exchange Register With Memory instruction, for example) without another system bus master receiving intervening memory cycles. This is useful in multiprocessor system configurations to accomplish "test and set lock" operations. The LOCK signal is activated (forced LOW) in the clock cycle following decoding of the software "LOCK" prefix instruction. It is deactivated at the end of the last bus cycle of the instruction following the "LOCK" prefix instruction. While LOCK is active a request on a RQ/GT pin will be recorded and then honored at the end of the LOCK.

External Synchronization Via TEST

As an alternative to interrupts, the 80C86 provides a single software-testable input pin ($\overline{\text{TEST}}$). This input is utilized by executing a WAIT instruction. The single WAIT instruction is repeatedly executed until the $\overline{\text{TEST}}$ input goes active (LOW). The execution of WAIT does not consume bus cycles once the queue is full.

If a local bus request occurs during WAIT execution, the 80C86 three-states all output drivers while inputs and I/O pins are held at valid logic levels by internal bus-hold circuits. If interrupts are enabled, the 80C86 will recognize interrupts and process them when it regains control of the bus. The WAIT instruction is then refetched, and re-executed.

TABLE 4. 80C86 REGISTER



Basic System Timing

Typical system configurations for the processor operating in minimum mode and in maximum mode are shown in Figures 6A and 6B, respectively. In minimum mode, the MN/ $\overline{\rm MX}$ pin is strapped to VCC and the processor emits bus control signals (e.g. $\overline{\rm RD}$, $\overline{\rm WR}$, etc.) directly. In maximum mode, the MN/ $\overline{\rm MX}$ pin is strapped to GND and the processor emits coded status information which the 82C88 bus controller uses to generate MULTIBUS compatible bus control signals. Figure 3 shows the signal timing relationships.

System Timing - Minimum System

The read cycle begins in T1 with the assertion of the Address Latch Enable (ALE) signal. The trailing (low-going) edge of this signal is used to latch the address information, which is valid on the address/data bus (AD0-AD15) at this time, into the 82C82/82C83 latch. The $\overline{\rm BHE}$ and A0 signals address the low, high or both bytes. From T1 to T4 the M/ $\overline{\rm IO}$ signal indicates a memory or I/O operation. At T2, the address is removed from the address/data bus and the bus is held at the last valid logic state by internal bus hold

devices. The read control signal is also asserted at T2. The read ($\overline{\text{RD}}$) signal causes the addressed device to enable its data bus drivers to the local bus. Some time later, valid data will be available on the bus and the addressed device will drive the READY line HIGH. When the processor returns the read signal to a HIGH level, the addressed device will again three-state its bus drivers. If a transceiver (82C86/82C87) is required to buffer the 80C86 local bus, signals DT/R and $\overline{\text{DEN}}$ are provided by the 80C86.

A write cycle also begins with the assertion of ALE and the emission of the address. The M/\overline{IO} signal is again asserted to indicate a memory or I/O write operation. In T2, immediately following the address emission, the processor emits the data to be written into the addressed location. This data remains valid until at least the middle of T4. During T2, T3 and TW, the processor asserts the write control signal. The write (\overline{WR}) signal becomes active at the beginning of T2 as opposed to the read which is delayed somewhat into T2 to provide time for output drivers to become inactive.

The BHE and A0 signals are used to select the proper byte(s) of the memory/IO word to be read or written according to Table 5.

TABLE 5.

BHE	A0	CHARACTERISTICS
0	0	Whole word
0	1	Upper Byte From/To Odd Address
1	0	Lower Byte From/To Even Address
1	1	None

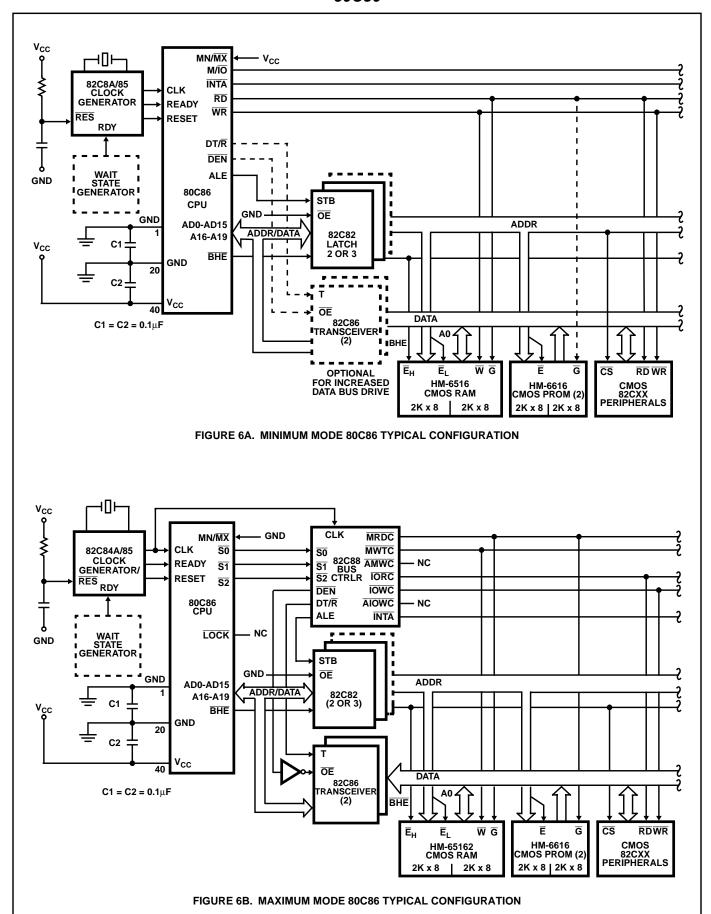
I/O ports are addressed in the same manner as memory location. Even addressed bytes are transferred on the D7-D0 bus lines and odd address bytes on D15-D8.

The basic difference between the interrupt acknowledge cycle and a read cycle is that the interrupt acknowledge signal ($\overline{\text{INTA}}$) is asserted in place of the read ($\overline{\text{RD}}$) signal and the address bus is held at the last valid logic state by internal bus hold devices. (See Figure 4). In the second of two successive $\overline{\text{INTA}}$ cycles a byte of information is read from the data bus (D7-D0) as supplied by the interrupt system logic (i.e., 82C59A Priority Interrupt Controller). This byte identifies the source (type) of the interrupt. It is multiplied by four and used as a pointer into an interrupt vector lookup table, as described earlier.

Bus Timing - Medium Size Systems

For medium complexity systems the MN/MX pin is connected to GND and the 82C88 Bus Controller is added to the system as well as an 82C82/82C83 latch for latching the system address, and an 82C86/82C87 transceiver to allow for bus loading greater than the 80C86 is capable of handling. Signals ALE, DEN, and DT/R are generated by the 82C88 instead of the processor in this configuration, although their timing remains relatively the same. The 80C86 status outputs ($\overline{S2}$, $\overline{S1}$ and $\overline{S0}$) provide type-of-cycle information and become 82C88 inputs. This bus cycle information specifies read (code, data or I/O), write (data or I/O), interrupt acknowledge, or software halt. The 82C88 issues control signals specifying memory read or write, I/O read or write, or interrupt acknowledge. The 82C88 provides two types of write strobes, normal and advanced, to be applied as required. The normal write strobes have data valid at the leading edge of write. The advanced write strobes have the same timing as read strobes, and hence, data is not valid at the leading edge of write. The 82C86/82C87 transceiver receives the usual T and \overline{OE} inputs from the 82C88 DT/ \overline{R} and DEN signals.

The pointer into the interrupt vector table, which is passed during the second $\overline{\text{INTA}}$ cycle, can be derived from an 82C59A located on either the local bus or the system bus. If the master 82C59A Priority Interrupt Controller is positioned on the local bus, the 82C86/82C87 transceiver must be disabled when reading from the master 82C59A during the interrupt acknowledge sequence and software "poll".



Absolute Maximum Ratings

Thermal Information

Supply Voltage
Input, Output or I/O Voltage GND -0.5V to V_{CC} +0.5V
Storage Temperature Range65°C to +150°C
Junction Temperature
Ceramic Packages
Plastic Packages
Lead Temperature (Soldering 10s)+300°C
(Lead tips only for surface mount packages)

Thermal Resistance (Typical, Note 1)	θ_{JA} (°C/W)	θ_{JC} (oC/W)
PDIP Package	50	N/A
PLCC Package	46	N/A
SBDIP Package	30	6
CLCC Package	40	6
Gate Count		. 9750 Gates

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Operating Conditions

Operating Supply Voltage +4.5V to +5.5V	Operating Temperature Range: C80C86/-2 0°C to +70°C
	I80C86/-240°C to +85°C
	M80C86/-255°C to +125°C

DC Electrical Specifications V_{CC} = 5.0V, $\pm 10\%$; T_A = 0°C to +70°C (C80C86, C80C86-2) $V_{CC} = 5.0V, \pm 10\%; T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (180C86, 180C86-2)}$ $V_{CC} = 5.0V, \pm 10\%; T_A = -55^{\circ}C \text{ to } +125^{\circ}C \text{ (M80C86)}$ $V_{CC} = 5.0V, \pm 5\%;$ $T_A = -55^{\circ}C \text{ to } +125^{\circ}C \text{ (M80C86-2)}$

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITION
V_{IH}	Logical One Input Voltage	2.0 2.2		V V	C80C86, I80C86 (Note 5) M80C86 (Note 5)
V _{IL}	Logical Zero Input Voltage		0.8	V	
V _{IHC}	CLK Logical One Input Voltage	V _{CC} -0.8		V	
V_{ILC}	CLK Logical Zero Input Voltage		0.8	V	
V _{OH}	Output High Voltage	3.0 V _{CC} -0.4		V V	I _{OH} = -2.5mA I _{OH} = -100μA
V _{OL}	Output Low Voltage		0.4	V	I _{OL} = +2.5mA
Ι _Ι	Input Leakage Current	-1.0	1.0	μА	V _{IN} = GND or V _{CC} DIP Pins 17-19, 21-23, 33
I _{BHH}	Input Current-Bus Hold High	-40	-400	μΑ	V _{IN} = - 3.0V (Note 1)
I _{BHL}	Input Current-Bus Hold Low	40	400	μΑ	V _{IN} = - 0.8V (Note 2)
I _O	Output Leakage Current	-	-10.0	μΑ	V _{OUT} = GND (Note 4)
I _{CCSB}	Standby Power Supply Current	-	500	μΑ	V _{CC} = - 5.5V (Note 3)
I _{CCOP}	Operating Power Supply Current	-	10	mA/MHz	FREQ = Max, V _{IN} = V _{CC} or GND, Outputs Open

Capacitance $T_A = 25^{\circ}C$

SYMBOL	PARAMETER	TYPICAL	UNITS	TEST CONDITIONS
C _{IN}	Input Capacitance	25	pF	FREQ = 1MHz. All measurements are referenced to device GND
C _{OUT}	Output Capacitance	25	pF	FREQ = 1MHz. All measurements are referenced to device GND
C _{I/O}	I/O Capacitance	25	pF	FREQ = 1MHz. All measurements are referenced to device GND

- 2. IBHH should be measured after raising V_{IN} to V_{CC} and then lowering to 3.0V on the following pins 2-16, 26-32, 34-39.
- 3. IBHL should be measured after lowering V_{IN} to GND and then raising to 0.8V on the following pins: 2-16, 34-39.
- 4. ICCSB tested during clock high time after halt instruction executed. $V_{IN} = V_{CC}$ or GND, $V_{CC} = 5.5V$, Outputs unloaded.
- 5. IO should be measured by putting the pin in a high impedance state and then driving V_{OUT} to GND on the following pins: 26-29 and 32.
- 6. MN/\overline{MX} is a strap option and should be held to V_{CC} or GND.

AC Electrical Specifications

 $V_{CC} = 5.0V \pm 10\%$; $T_A = 0^{\circ}C$ to +70°C (C80C86, C80C86-2)

 $V_{CC} = 5.0V \pm 100\%$; $T_A = -40^{\circ}C$ to +85°C (I80C86, I80C86-2)

 $V_{CC} = 5.0V \pm 100\%$; $T_A = -55^{\circ}C$ to $+125^{\circ}C$ (M80C86)

 $V_{CC} = 5.0V \pm 5\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86-2)

MINIMUM COMPLEXITY SYSTEM

			80C86		80C86-	2		
s	YMBOL	PARAMETER	MIN	мах	MIN	MAX	UNITS	TEST CONDITIONS
TIMIT	IG REQUIRE	MENTS	•	•		•	•	
(1)	TCLCL	Cycle Period	200		125		ns	
(2)	TCLCH	CLK Low Time	118		68		ns	
(3)	TCHCL	CLK High Time	69		44		ns	
(4)	TCH1CH2	CLK Rise Time		10		10	ns	From 1.0V to 3.5V
(5)	TCL2C1	CLK Fall Time		10		10	ns	From 3.5V to 1.0V
(6)	TDVCL	Data In Setup Time	30		20		ns	
(7)	TCLDX1	Data In Hold Time	10		10		ns	
(8)	TR1VCL	RDY Setup Time into 82C84A (Notes 7, 8)	35		35		ns	
(9)	TCLR1X	RDY Hold Time into 82C84A (Notes 7, 8)	0		0		ns	
(10)	TRYHCH	READY Setup Time into 80C86	118		68		ns	
(11)	TCHRYX	READY Hold Time into 80C86	30		20		ns	
(12)	TRYLCL	READY Inactive to CLK (Note 9)	-8		-8		ns	
(13)	THVCH	HOLD Setup Time	35		20		nS	
(14)	TINVCH	INTR, NMI, TEST Setup Time (Note 8)	30		15		ns	
(15)	TILIH	Input Rise Time (Except CLK)		15		15	ns	From 0.8V to 2.0V
(16)	TIHIL	Input Fall Time (Except CLK)		15		15	ns	From 2.0V to 0.8V
TIMI	NG RESPON	SES	•					•
(17)	TCLAV	Address Valid Delay	10	110	10	60	ns	C _L = 100pF
(18)	TCLAX	Address Hold Time	10		10		ns	C _L = 100pF
(19)	TCLAZ	Address Float Delay	TCLAX	80	TCLAX	50	ns	C _L = 100pF
(20)	TCHSZ	Status Float Delay		80		50	ns	C _L = 100pF
(21)	TCHSV	Status Active Delay	10	110	10	60	ns	C _L = 100pF
(22)	TLHLL	ALE Width	TCLCH-20		TCLCH-10		ns	C _L = 100pF
(23)	TCLLH	ALE Active Delay		80		50	ns	C _L = 100pF
(24)	TCHLL	ALE Inactive Delay		85		55	ns	C _L = 100pF

AC Electrical Specifications

 $V_{CC} = 5.0V \pm 10\%$; $T_A = 0^{\circ}C$ to +70°C (C80C86, C80C86-2)

 $V_{CC} = 5.0V \pm 100\%$; $T_A = -40^{\circ}C$ to +85°C (I80C86, I80C86-2)

 $V_{CC} = 5.0V \pm 100\%$; $T_A = -55^{\circ}C$ to $+125^{\circ}C$ (M80C86)

 $V_{CC} = 5.0V \pm 5\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86-2) (Continued)

MINIMUM COMPLEXITY SYSTEM

			80C86		80C86-	2		TEST
s	YMBOL	PARAMETER	MIN	МАХ	MIN	MAX	UNITS	CONDITIONS
(25)	TLLAX	Address Hold Time to ALE Inactive	TCHCL-10		TCHCL-10		ns	C _L = 100pF
(26)	TCLDV	Data Valid Delay	10	110	10	60	ns	C _L = 100pF
(27)	TCLDX2	Data Hold Time	10		10		ns	C _L = 100pF
(28)	TWHDX	Data Hold Time After WR	TCLCL-30		TCLCL-30		ns	C _L = 100pF
(29)	TCVCTV	Control Active Delay 1	10	110	10	70	ns	C _L = 100pF
(30)	TCHCTV	Control Active Delay 2	10	110	10	60	ns	C _L = 100pF
(31)	TCVCTX	Control Inactive Delay	10	110	10	70	ns	C _L = 100pF
(32)	TAZRL	Address Float to READ Active	0		0		ns	C _L = 100pF
(33)	TCLRL	RD Active Delay	10	165	10	100	ns	C _L = 100pF
(34)	TCLRH	RD Inactive Delay	10	150	10	80	ns	C _L = 100pF
(35)	TRHAV	RD Inactive to Next Address Active	TCLCL-45		TCLCL-40		ns	C _L = 100pF
(36)	TCLHAV	HLDA Valid Delay	10	160	10	100	ns	C _L = 100pF
(37)	TRLRH	RD Width	2TCLCL-75		2TCLCL-50		ns	C _L = 100pF
(38)	TWLWH	WR Width	2TCLCL-60		2TCLCL-40		ns	C _L = 100pF
(39)	TAVAL	Address Valid to ALE Low	TCLCH-60		TCLCH-40		ns	C _L = 100pF
(40)	TOLOH	Output Rise Time		20		15	ns	From 0.8V to 2.0V
(41)	TOHOL	Output Fall Time		20		15	ns	From 2.0V to 0.8V

- 7. Signal at 82C84A shown for reference only.
- 8. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.
- 9. Applies only to T2 state (8ns into T3).

Waveforms

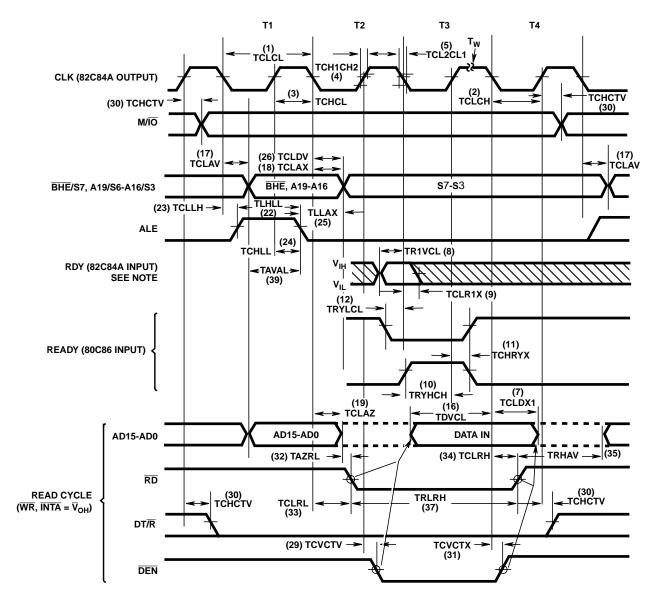


FIGURE 7A. BUS TIMING - MINIMUM MODE SYSTEM

NOTE: Signals at 82C84A are shown for reference only. RDY is sampled near the end of T2, T3, TW to determine if TW machine states are to be inserted.

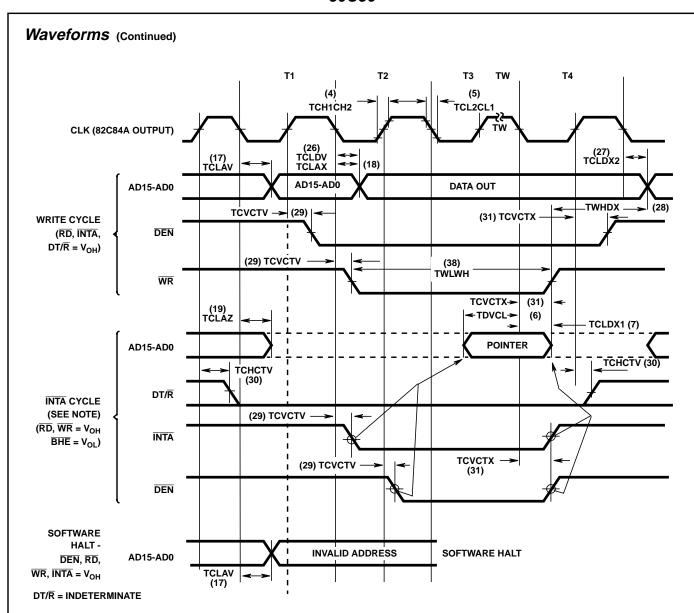


FIGURE 7B. BUS TIMING - MINIMUM MODE SYSTEM

NOTE: Two INTA cycles run back-to-back. The 80C86 local ADDR/DATA bus is floating during both INTA cycles. Control signals are shown for the second INTA cycle.

AC Electrical Specifications V_{CC} = 5.0V $\pm 10\%$ T_A = 0°C to +70°C (C80C86, C80C86-2)

 $V_{CC} = 5.0V \pm 10\%$; $T_A = -40^{\circ}C$ to +85°C (180C86, 180C86-2)

 $V_{CC} = 5.0V \pm 10\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86) $V_{CC} = 5.0V \pm 5\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86-2)

MAX MODE SYSTEM (USING 82C88 BUS CONTROLLER)

	TIN	MING REQUIREMENTS	80	C86	80	C86-2		
S	YMBOL	PARAMETER	MIN	MAX	MIN	MAX	UNITS	TEST CONDITIONS
(1)	TCLCL	CLK Cycle Period	200		125		ns	
(2)	TCLCH	CLK Low Time	118		68		ns	
(3)	TCHCL	CLK High Time	69		44		ns	
(4)	TCH1CH2	CLK Rise Time		10		10	ns	From 1.0V to 3.5V
(5)	TCL2CL1	CLK Fall Time		10		10	ns	From 3.5V to 1.0V
(6)	TDVCL	Data in Setup Time	30		20		ns	
(7)	TCLDX1	Data In Hold Time	10		10		ns	
(8)	TR1VCL	RDY Setup Time into 82C84A (Notes 10, 11)	35		35		ns	
(9)	TCLR1X	RDY Hold Time into 82C84A (Notes 10, 11)	0		0		ns	
(10)	TRYHCH	READY Setup Time into 80C86	118		68		ns	
(11)	TCHRYX	READY Hold Time into 80C86	30		20		ns	
(12)	TRYLCL	READY Inactive to CLK (Note 12)	-8		-8		ns	
(13)	TINVCH	Setup Time for Recognition (INTR, NMI, TEST) (Note 11)	30		15		ns	
(14)	TGVCH	RQ/GT Setup Time	30		15		ns	
(15)	TCHGX	RQ Hold Time into 80C86 (Note 13)	40	TCHCL+ 10	30	TCHCL+ 10	ns	
(16)	TILIH	Input Rise Time (Except CLK)		15		15	ns	From 0.8V to 2.0V
(17)	TIHIL	Input Fall Time (Except CLK)		15		15	ns	From 2.0V to 0.8V
TIMIN	IG RESPONS	SES	•	•		•		•
(18)	TCLML	Command Active Delay (Note 10)	5	35	5	35	ns	$C_L = 100 pF for All 80C86 Outputs (In Addition to 80C86 Self Load)$
(19)	TCLMH	Command Inactive (Note 10)	5	35	5	35	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(20)	TRYHSH	READY Active to Status Passive (Notes 12, 14)		110		65	ns	$C_L = 100 pF for All 80 C86 Outputs (In Addition to 80 C86 Self Load)$
(21)	TCHSV	Status Active Delay	10	110	10	60	ns	$C_L = 100 pF$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(22)	TCLSH	Status Inactive Delay (Note 14)	10	130	10	70	ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)

AC Electrical Specifications $V_{CC} = 5.0V \pm 10\%$ $T_A = 0^{o}C$ to +70°C (C80C86, C80C86-2) $V_{CC} = 5.0V \pm 10\%$; $T_A = -40^{o}C$ to +85°C (I80C86, I80C86-2)

 $V_{CC} = 5.0V \pm 10\%$; $T_A = -55^{\circ}C$ to $+125^{\circ}C$ (M80C86)

 $V_{CC} = 5.0V \pm 5\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86-2) (Continued)

MAX MODE SYSTEM (USING 82C88 BUS CONTROLLER)

	TIM	MING REQUIREMENTS	80	C86	800	86-2		
s	YMBOL	PARAMETER	MIN	MAX	MIN	MAX	UNITS	TEST CONDITIONS
(23)	TCLAV	Address Valid Delay	10	110	10	60	ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(24)	TCLAX	Address Hold Time	10		10		ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(25)	TCLAZ	Address Float Delay	TCLAX	80	TCLAX	50	ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(26)	TCHSZ	Status Float Delay		80		50	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(27)	TSVLH	Status Valid to ALE High (Note 10)		20		20	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(28)	TSVMCH	Status Valid to MCE High (Note 10)		30		30	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(29)	TCLLH	CLK low to ALE Valid (Note 10)		20		20	ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(30)	TCLMCH	CLK low to MCE High (Note 10)		25		25	ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(31)	TCHLL	ALE Inactive Delay (Note 10)	4	18	4	18	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(32)	TCLMCL	MCE Inactive Delay (Note 10)		15		15	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(33)	TCLDV	Data Valid Delay	10	110	10	60	ns	C _L = 100pF for All 80C86 Outputs (In Addition to 80C86 Self Load)
(34)	TCLDX2	Data Hold Time	10		10		ns	$C_L = 100 \mathrm{pF}$ for All 80C86 Outputs (In Addition to 80C86 Self Load)

AC Electrical Specifications $V_{CC} = 5.0V \pm 10\%$ $T_A = 0^{\circ}C$ to +70°C (C80C86, C80C86-2)

 $V_{CC} = 5.0V \pm 10\%$; $T_A = -40^{\circ}C$ to +85°C (I80C86, I80C86-2)

 $V_{CC} = 5.0V \pm 10\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86)

 $V_{CC} = 5.0 V \pm 5\%$; $T_A = -55^{\circ}C$ to +125°C (M80C86-2) (Continued)

MAX MODE SYSTEM (USING 82C88 BUS CONTROLLER)

	TII	MING REQUIREMENTS	80	C86	800	86-2		
s	YMBOL	PARAMETER	MIN	MAX	MIN	MAX	UNITS	TEST CONDITIONS
(35)	TCVNV	Control Active Delay (Note 10)	5	45	5	45	ns	$C_L = 100 pF$ for All 80C86 Outputs (In Addition to 80C86 Self Load)
(36)	TCVNX	Control Inactive Delay (Note 10)	10	45	10	45	ns	C _L = 100pF
(37)	TAZRL	Address Float to Read Active	0		0		ns	C _L = 100pF
(38)	TCLRL	RD Active Delay	10	165	10	100	ns	C _L = 100pF
(39)	TCLRH	RD Inactive Delay	10	150	10	80	ns	C _L = 100pF
(40)	TRHAV	RD Inactive to Next Address Active	TCLCL -45		TCLCL -40		ns	C _L = 100pF
(41)	TCHDTL	Direction Control Active Delay (Note 10)		50		50	ns	C _L = 100pF
(42)	TCHDTH	Direction Control Inactive Delay (Note 10)		30		30	ns	C _L = 100pF
(43)	TCLGL	GT Active Delay	10	85	0	50	ns	C _L = 100pF
(44)	TCLGH	GT Inactive Delay	10	85	0	50	ns	C _L = 100pF
(45)	TRLRH	RD Width	2TCLC L -75		2TCLC L -50		ns	C _L = 100pF
(46)	TOLOH	Output Rise Time		20		15	ns	From 0.8V to 2.0V
(47)	TOHOL	Output Fall Time		20		15	ns	From 2.0V to 0.8V

- 10. Signal at 82C84A or 82C88 shown for reference only.
- 11. Setup requirement for asynchronous signal only to guarantee recognition at next CLK.
- 12. Applies only to T2 state (8ns into T3).
- 13. The 80C86 actively pulls the $\overline{RQ}/\overline{GT}$ pin to a logic one on the following clock low time.
- 14. Status lines return to their inactive (logic one) state after CLK goes low and READY goes high.

Waveforms T_1 T_3 T_4 T_2 (4) TCH1CH2 (1) (5) CL2CL1 CLK (23) TCLAV TCLCH TCHCL (3) QS0, QS1 TCLSH (21) TCHSV -(22) S2, S1, S0 (EXCEPT HALT) (33) (SEE NOTE 17) TCLDV < → (23) TCLAV TCLAV-> (23) TCLAX -(24)BHE/S7, A19/S6-A16/S3 BHE, A19-A16 S7-S3 TSVLH → (27) TCHLL (31) TCLLH ALE (82C88 OUTPUT) (29) NOTE TR1VCL (8) RDY (82C84 INPUT) TCLR1X (12) TRYLCL (11)TCHRYX **READY 80C86 INPUT)** TRYHSH (20) (24) (10) TRYHCH (6) TDVCL (25)TCLDX1 **READ CYCLE** TCLAV_ -- (23) TCLÁZ AD15-AD0 DATA IN AD15-AD0 (37) TAZRL (39) TCLRH TRHAV-(40) $\overline{\mathsf{RD}}$ (42) (41) TCHDTL TCHDTH TRLRH TCLRL (45) DT/R (38) TCLML (18) TCLMH-(19) 82C88 OUTPUTS SEE NOTES 15, 16 MRDC OR IORC (35) TCVNV -DEN

FIGURE 8A. BUS TIMING - MAXIMUM MODE (USING 82C88)

TCVNX-

- 15. Signals at 82C84A or 82C88 are shown for reference only. RDY is sampled near the end of T2, T3, TW to determine if TW machine states are to be inserted.
- 16. The issuance of the 82C88 command and control signals (MRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA, and DEN) lags the active high 82C88 CEN.
- 17. Status inactive in state just prior to T4.

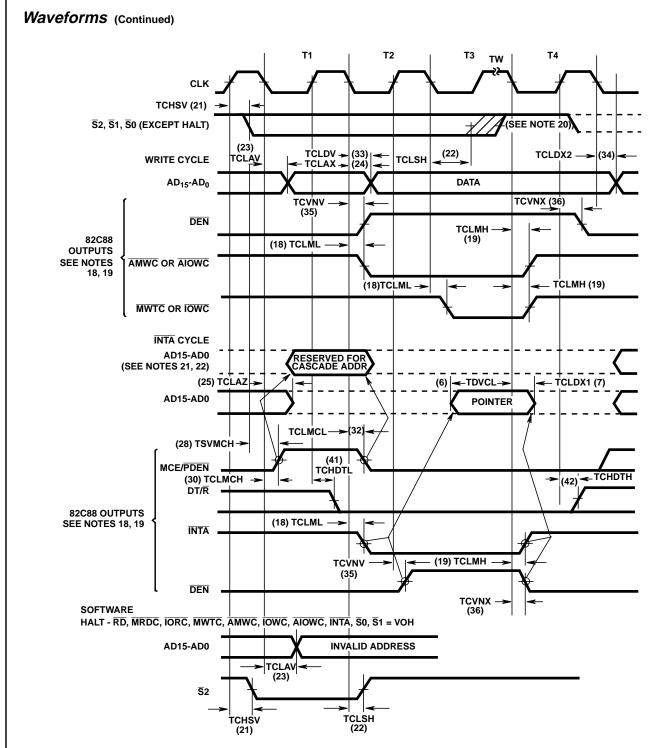
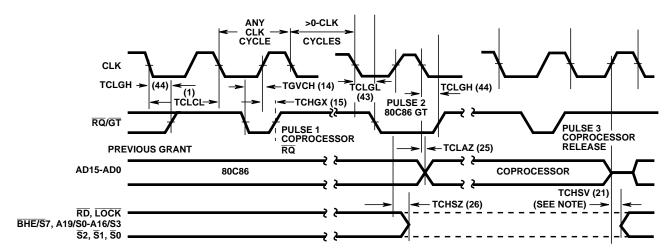


FIGURE 8B. BUS TIMING - MAXIMUM MODE (USING 82C88)

- 18. Signals at 82C84A or 82C86 are shown for reference only.
- 19. The issuance of the 82C88 command and control signals (MRDC, MWTC, AMWC, IORC, IOWC, AIOWC, INTA and DEN) lags the active high 82C88 CEN.
- 20. Status inactive in state just prior to T4.
- 21. Cascade address is valid between first and second INTA cycles.
- 22. Two INTA cycles run back-to-back. The 80C86 local ADDR/DATA bus is floating during both INTA cycles. Control for pointer address is shown for second INTA cycle.

Waveforms (Continued)



NOTE: The coprocessor may not drive the busses outside the region shown without risking contention.

FIGURE 9. REQUEST/GRANT SEQUENCE TIMING (MAXIMUM MODE ONLY)

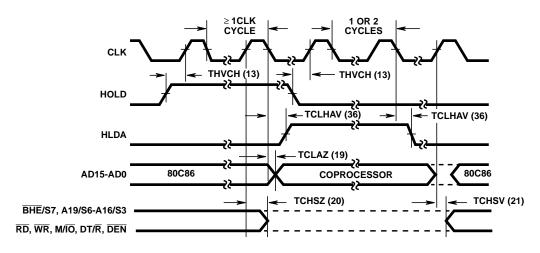
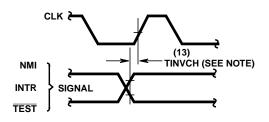


FIGURE 10. HOLD/HOLD ACKNOWLEDGE TIMING (MINIMUM MODE ONLY)



NOTE: Setup requirements for asynchronous signals only to guarantee recognition at next CLK.

FIGURE 11. ASYNCHRONOUS SIGNAL RECOGNITION

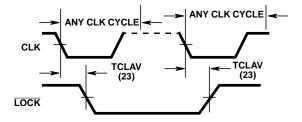


FIGURE 12. BUS LOCK SIGNAL TIMING (MAXIMUM MODE ONLY)

Waveforms (Continued)

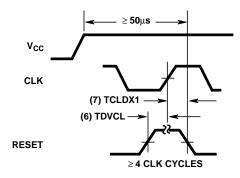
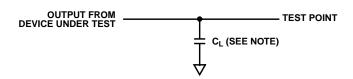


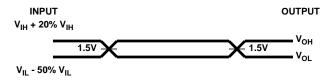
FIGURE 13. RESET TIMING

AC Test Circuit



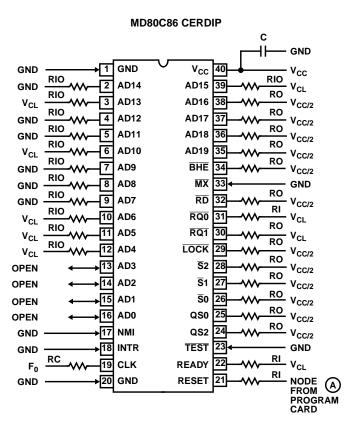
NOTE: Includes stay and jig capacitance.

AC Testing Input, Output Waveform



NOTE: AC Testing: All input signals (other than CLK) must switch between V_{ILMAX} -50% V_{IL} and V_{IHMIN} +20% V_{IH}. CLK must switch between 0.4V and V_{CC}.-0.4 Input rise and fall times are driven at 1ns/V.

Burn-In Circuits



NOTES:

 V_{CC} = 5.5V \pm 0.5V, GND = 0V.

Input voltage limits (except clock):

 V_{II} (maximum) = 0.4V

 V_{IH} (minimum) = 2.6V, V_{IH} (clock) = (V_{CC} -0.4V) minimum.

 $V_{CC/2}$ is external supply set to 2.7V $\pm 10\%.$

 V_{CL} is generated on program card (V_{CC} - 0.65V).

Pins 13 - 16 input sequenced instructions from internal hold devices.

 $F_0 = 100kHz \pm 10\%$.

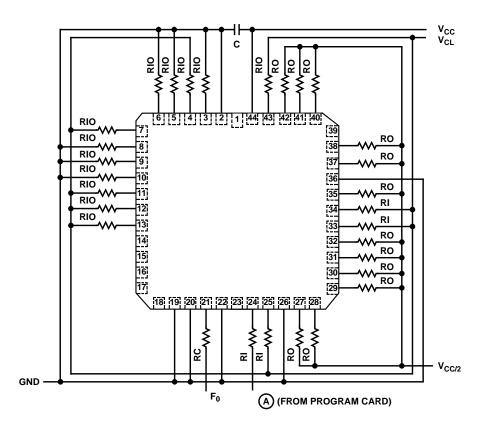
Node (A) = a 40 μ s pulse every 2.56ms.

COMPONENTS:

- 1. RI = $10k\Omega \pm 5\%$, 1/4W
- 2. RO = $1.2k\Omega \pm 5\%$. 1/4W
- 3. RIO = $2.7k\Omega \pm 5\%$, 1/4W
- 4. RC = $1k\Omega \pm 5\%$, 1/4W
- 5. $C = 0.01 \mu F$ (Minimum)

Burn-In Circuits (Continued)

MR80C86 CLCC



NOTES:

 $V_{CC} = 5.5V \pm 0.5V$, GND = 0V.

Input voltage limits (except clock):

 V_{IL} (maximum) = 0.4V

 V_{IH} (minimum) = 2.6V, V_{IH} (clock) = (V_{CC} -0.4V) minimum.

 $V_{CC/2}$ is external supply set to 2.7V $\pm 10\%.$

V_{CL} is generated on program card (V_{CC} - 0.65V).

Pins 13 - 16 input sequenced instructions from internal hold devices.

 $F_0 = 100 \text{kHz} \pm 10\%$.

Node (A) = a 40 μ s pulse every 2.56ms.

COMPONENTS:

- 1. RI = $10k\Omega \pm 5\%$, 1/4W
- 2. RO = $1.2k\Omega \pm 5\%$, 1/4W
- 3. RIO = $2.7k\Omega \pm 5\%$, 1/4W
- 4. RC = $1k\Omega \pm 5\%$, 1/4W5. C = $0.01\mu F$ (Minimum)

Metallization Topology

DIE DIMENSIONS: 249.2 x 290.9 x 19

METALLIZATION:

Type: Silicon - Aluminum Thickness: 11kÅ ±2kÅ **GLASSIVATION:**

Type: Nitrox

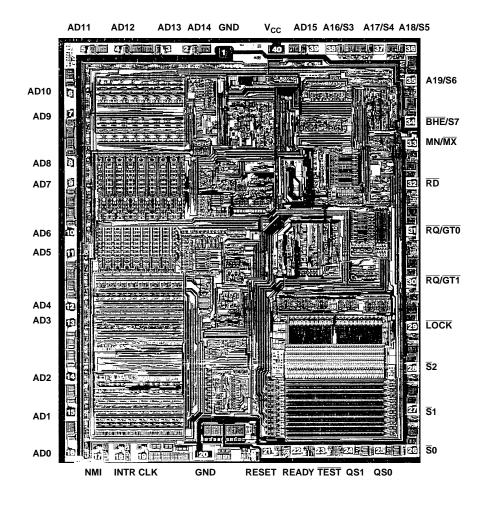
Thickness: 10kÅ ±2kÅ

WORST CASE CURRENT DENSITY:

 $1.5 \times 10^5 \text{ A/cm}^2$

Metallization Mask Layout

80C86



Instruction Set Summary

		INSTRUCTION CODE								
MNEMONIC AND DESCRIPTION	76543210	76543210	76543210	76543210						
DATA TRANSFER										
MOV = MOVE:										
Register/Memory to/from Register	100010dw	mod reg r/m								
Immediate to Register/Memory	1100011w	mod 0 0 0 r/m	data	data if w 1						
Immediate to Register	1 0 1 1 w reg	data	data if w 1							
Memory to Accumulator	1010000w	addr-low	addr-high							
Accumulator to Memory	1010001w	addr-low	addr-high							
Register/Memory to Segment Register ††	10001110	mod 0 reg r/m		l						
Segment Register to Register/Memory	10001100	mod 0 reg r/m								
PUSH = Push:										
Register/Memory	1111111	mod 1 1 0 r/m								
Register	0 1 0 1 0 reg									
Segment Register	0 0 0 reg 1 1 0									
POP = Pop:										
Register/Memory	10001111	mod 0 0 0 r/m								
Register	0 1 0 1 1 reg									
Segment Register	0 0 0 reg 1 1 1									
XCHG = Exchange:										
Register/Memory with Register	1000011w	mod reg r/m								
Register with Accumulator	1 0 0 1 0 reg									
IN = Input from:										
Fixed Port	1110010w	port								
Variable Port	1110110w									
OUT = Output to:										
Fixed Port	1110011w	port								
Variable Port	1110111w									
XLAT = Translate Byte to AL	11010111									
LEA = Load EA to Register2	10001101	mod reg r/m								
LDS = Load Pointer to DS	11000101	mod reg r/m								
LES = Load Pointer to ES	11000100	mod reg r/m								
LAHF = Load AH with Flags	10011111									
SAHF = Store AH into Flags	10011110									
PUSHF = Push Flags	10011100									
POPF = Pop Flags	10011101									
ARITHMETIC										
ADD = Add:										
Register/Memory with Register to Either	00000dw	mod reg r/m								
Immediate to Register/Memory	100000sw	mod 0 0 0 r/m	data	data if s:w = 0°						
Immediate to Accumulator	0000010w	data	data if w = 1							
ADC = Add with Carry:										
Register/Memory with Register to Either	000100dw	mod reg r/m								

Instruction Set Summary (Continued)

MNEMONIC AND DESCRIPTION	INSTRUCTION CODE			
	76543210	76543210	76543210	76543210
Immediate to Register/Memory	100000sw	mod 0 1 0 r/m	data	data if s:w = 01
Immediate to Accumulator	0001010w	data	data if w = 1	
INC = Increment:				•
Register/Memory	1111111w	mod 0 0 0 r/m		
Register	0 1 0 0 0 reg		•	
AAA = ASCII Adjust for Add	00110111			
DAA = Decimal Adjust for Add	00100111			
SUB = Subtract:				
Register/Memory and Register to Either	001010dw	mod reg r/m		
Immediate from Register/Memory	100000sw	mod 1 0 1 r/m	data	data if s:w = 01
Immediate from Accumulator	0010110w	data	data if w = 1	
SBB = Subtract with Borrow				•
Register/Memory and Register to Either	000110dw	mod reg r/m		
Immediate from Register/Memory	100000sw	mod 0 1 1 r/m	data	data if s:w = 01
Immediate from Accumulator	0001110w	data	data if w = 1	
DEC = Decrement:				•
Register/Memory	1111111w	mod 0 0 1 r/m		
Register	0 1 0 0 1 reg		ı	
NEG = Change Sign	1111011w	mod 0 1 1 r/m		
CMP = Compare:			ı	
Register/Memory and Register	001110dw	mod reg r/m		
Immediate with Register/Memory	100000sw	mod 1 1 1 r/m	data	data if s:w = 01
Immediate with Accumulator	0011110w	data	data if w = 1	
AAS = ASCII Adjust for Subtract	00111111			•
DAS = Decimal Adjust for Subtract	00101111			
MUL = Multiply (Unsigned)	1111011w	mod 1 0 0 r/m		
IMUL = Integer Multiply (Signed)	1111011w	mod 1 0 1 r/m		
AAM = ASCII Adjust for Multiply	11010100	00001010		
DIV = Divide (Unsigned)	1111011w	mod 1 1 0 r/m		
IDIV = Integer Divide (Signed)	1111011w	mod 1 1 1 r/m		
AAD = ASCII Adjust for Divide	11010101	00001010		
CBW = Convert Byte to Word	10011000		l	
CWD = Convert Word to Double Word	10011001			
LOGIC				
NOT = Invert	1111011w	mod 0 1 0 r/m		
SHL/SAL = Shift Logical/Arithmetic Left	110100vw	mod 1 0 0 r/m		
SHR = Shift Logical Right	110100vw	mod 1 0 1 r/m		
SAR = Shift Arithmetic Right	110100 v w	mod 1 0 1 1/m		
ROL = Rotate Left	110100vw	mod 0 0 0 r/m		
ROR = Rotate Right	110100vw	mod 0 0 0 1/m		
RCL = Rotate Through Carry Flag Left	110100VW	mod 0 1 0 r/m		

Instruction Set Summary (Continued)

	INSTRUCTION CODE			
MNEMONIC AND DESCRIPTION	76543210	76543210	76543210	76543210
RCR = Rotate Through Carry Right	110100vw	mod 0 1 1 r/m		
AND = And:			•	
Reg./Memory and Register to Either	0010000dw	mod reg r/m		
Immediate to Register/Memory	1000000w	mod 1 0 0 r/m	data	data if w = 1
Immediate to Accumulator	0010010w	data	data if w = 1	
TEST = And Function to Flags, No Result:			_	
Register/Memory and Register	1000010w	mod reg r/m		
Immediate Data and Register/Memory	1111011w	mod 0 0 0 r/m	data	data if w = 1
Immediate Data and Accumulator	1010100w	data	data if w = 1	
OR = Or:				_
Register/Memory and Register to Either	000010dw	mod reg r/m		
Immediate to Register/Memory	1000000w	mod 1 0 1 r/m	data	data if w = 1
Immediate to Accumulator	0000110w	data	data if w = 1	
XOR = Exclusive or:				•
Register/Memory and Register to Either	001100dw	mod reg r/m		
Immediate to Register/Memory	1000000w	mod 1 1 0 r/m	data	data if w = 1
Immediate to Accumulator	0011010w	data	data if w = 1	
STRING MANIPULATION	ll			
REP = Repeat	1111001z			
MOVS = Move Byte/Word	1010010w			
CMPS = Compare Byte/Word	1010011w			
SCAS = Scan Byte/Word	1010111w			
LODS = Load Byte/Word to AL/AX	1010110w			
STOS = Stor Byte/Word from AL/A	1010101w			
CONTROL TRANSFER				
CALL = Call:				
Direct Within Segment	11101000	disp-low	disp-high	7
Indirect Within Segment	11111111	mod 0 1 0 r/m		
Direct Intersegment	10011010	offset-low	offset-high	1
		seg-low	seg-high	
Indirect Intersegment	1111111	mod 0 1 1 r/m		_
JMP = Unconditional Jump:				
Direct Within Segment	11101001	disp-low	disp-high	7
Direct Within Segment-Short	11101011	disp		J
Indirect Within Segment	1111111	mod 1 0 0 r/m		
Direct Intersegment	11101010	offset-low	offset-high	1
set intercognient		seg-low	seg-high	1
Indirect Intersegment	11111111	mod 1 0 1 r/m	30g mgn	_
RET = Return from CALL:		11100 1 0 1 1/111		
Within Segment	11000011			
Within Seg Adding Immed to SP	11000011	data-low	data-high	1

Instruction Set Summary (Continued)

	INSTRUCTION CODE			
MNEMONIC AND DESCRIPTION	76543210	76543210	76543210	76543210
Intersegment	11001011			
Intersegment Adding Immediate to SP	11001010	data-low	data-high	
JE/JZ = Jump on Equal/Zero	01110100	disp		-
JL/JNGE = Jump on Less/Not Greater or Equal	01111100	disp		
JLE/JNG = Jump on Less or Equal/ Not Greater	01111110	disp		
JB/JNAE = Jump on Below/Not Above or Equal	01110010	disp		
JBE/JNA = Jump on Below or Equal/Not Above	01110110	disp		
JP/JPE = Jump on Parity/Parity Even	01111010	disp		
JO = Jump on Overflow	01110000	disp		
JS = Jump on Sign	01111000	disp		
JNE/JNZ = Jump on Not Equal/Not Zero	01110101	disp		
JNL/JGE = Jump on Not Less/Greater or Equal	01111101	disp		
JNLE/JG = Jump on Not Less or Equal/Greater	01111111	disp		
JNB/JAE = Jump on Not Below/Above or Equal	01110011	disp		
JNBE/JA = Jump on Not Below or Equal/Above	01110111	disp		
JNP/JPO = Jump on Not Par/Par Odd	01111011	disp		
JNO = Jump on Not Overflow	01110001	disp		
JNS = Jump on Not Sign	01111001	disp		
LOOP = Loop CX Times	11100010	disp		
LOOPZ/LOOPE = Loop While Zero/Equal	11100001	disp		
LOOPNZ/LOOPNE = Loop While Not Zero/Equal	11100000	disp		
JCXZ = Jump on CX Zero	11100011	disp		
INT = Interrupt			•	
Type Specified	11001101	type		
Type 3	11001100		'	
INTO = Interrupt on Overflow	11001110			
IRET = Interrupt Return	11001111			
PROCESSOR CONTROL				
CLC = Clear Carry	11111000			
CMC = Complement Carry	11110101			
STC = Set Carry	11111001			
CLD = Clear Direction	11111100			
STD = Set Direction	11111101			
CLI = Clear Interrupt	11111010			
ST = Set Interrupt	11111011			
HLT = Halt	11110100			
WAIT = Wait	10011011			
ESC = Escape (to External Device)	11011xxx	mod x x x r/m		
LOCK = Bus Lock Prefix	11110000		•	

Instruction Set Summary (Continued)

	INSTRUCTION CODE			
MNEMONIC AND DESCRIPTION	76543210	76543210	76543210	76543210

NOTES:

AL = 8-bit accumulator

AX = 16-bit accumulator

CX = Count register

DS= Data segment

ES = Extra segment

Above/below refers to unsigned value.

Greater = more positive;

Less = less positive (more negative) signed values

if d = 1 then "to" reg; if d = 0 then "from" reg

if w = 1 then word instruction; if w = 0 then byte instruction

if mod = 11 then r/m is treated as a REG field

if mod = 00 then DISP = O†, disp-low and disp-high are absent

if mod = 01 then DISP = disp-low sign-extended 16-bits, disp-high is absent

if mod = 10 then DISP = disp-high:disp-low

if r/m = 000 then EA = (BX) + (SI) + DISP

if r/m = 001 then EA = (BX) + (DI) + DISP

if r/m = 010 then EA = (BP) + (SI) + DISP

if r/m = 011 then EA = (BP) + (DI) + DISP

if r/m = 100 then EA = (SI) + DISP

if r/m = 101 then EA = (DI) + DISP

if r/m = 110 then EA = (BP) + DISP †

if r/m = 111 then EA = (BX) + DISP

DISP follows 2nd byte of instruction (before data if required)

† except if mod = 00 and r/m = 110 then EA = disp-high: disp-low.

†† MOV CS, REG/MEMORY not allowed.

if s:w = 01 then 16-bits of immediate data form the operand.

if s:w. = 11 then an immediate data byte is sign extended to form the 16-bit operand.

if v = 0 then "count" = 1; if v = 1 then "count" in (C_1)

x = don't care

z is used for string primitives for comparison with ZF FLAG.

SEGMENT OVERRIDE PREFIX

001 reg 11 0

REG is assigned according to the following table:

16-BIT (w = 1)	8-BIT (w = 0)	SEGMENT
000 AX	000 AL	00 ES
001 CX	001 CL	01 CS
010 DX	010 DL	10 SS
011 BX	011 BL	11 DS
100 SP	100 AH	00 ES
101 BP	101 CH	00 ES
110 SI	110 DH	00 ES
111 DI	111 BH	00 ES

Instructions which reference the flag register file as a 16-bit object use the symbol FLAGS to represent the file:

FLAGS =

X:X:X:X:(OF):(DF):(IF):(IF):(SF):(ZF):X:(AF):X:(PF):X:(CF)

Mnemonics © Intel, 1978